



AOT7N60/AOTF7N60

600V, 7A N-Channel MOSFET

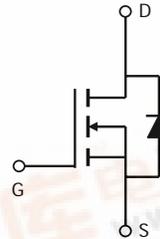
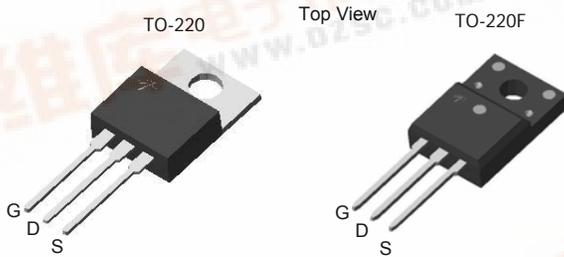
General Description

The AOT7N60 & AOTF7N60 have been fabricated using an advanced high voltage MOSFET process that is designed to deliver high levels of performance and robustness in popular AC-DC applications. By providing low $R_{DS(on)}$, C_{iss} and C_{rss} along with guaranteed avalanche capability these parts can be adopted quickly into new and existing offline power supply designs.

Features

V_{DS} (V) = 700V @ 150°C
 I_D = 7A
 $R_{DS(ON)} < 1.2\Omega$ ($V_{GS} = 10V$)

100% UIS Tested!
100% R_g Tested!
 C_{iss} , C_{oss} , C_{rss} Tested!



Absolute Maximum Ratings $T_A=25^\circ\text{C}$ unless otherwise noted

Parameter	Symbol	AOT7N60	AOTF7N60	Units
Drain-Source Voltage	V_{DS}	600		V
Gate-Source Voltage	V_{GS}	± 30		V
Continuous Drain Current	I_D	$T_C=25^\circ\text{C}$	7	7*
		$T_C=100^\circ\text{C}$	4.4	4.4*
Pulsed Drain Current ^C	I_{DM}	28		A
Avalanche Current ^{C, G}	I_{AR}	3		A
Repetitive avalanche energy ^{C, G}	E_{AR}	135		mJ
Single pulsed avalanche energy ^G	E_{AS}	270		mJ
Peak diode recovery dv/dt	dv/dt	5		V/ns
Power Dissipation ^B	P_D	$T_C=25^\circ\text{C}$	176	38.5
		Derate above 25°C	1.4	0.3
Junction and Storage Temperature Range	T_J, T_{STG}	-50 to 150		°C
Maximum lead temperature for soldering purpose, 1/8" from case for 5 seconds	T_L	300		°C

Thermal Characteristics

Parameter	Symbol	AOT7N60	AOTF7N60	Units
Maximum Junction-to-Ambient ^{A, D}	$R_{\theta JA}$	65	65	°C/W
Maximum Case-to-Sink ^A	$R_{\theta CS}$	0.5	--	°C/W
Maximum Junction-to-Case	$R_{\theta JC}$	0.71	3.25	°C/W

^A Drain current limited by maximum junction temperature.



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Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
STATIC PARAMETERS						
BV _{DSS}	Drain-Source Breakdown Voltage	I _D =250μA, V _{GS} =0V, T _J =25°C	600			V
		I _D =250μA, V _{GS} =0V, T _J =150°C		700		V
BV _{DSS} /ΔT _J	Breakdown Voltage Temperature Coefficient	I _D =250μA, V _{GS} =0V		0.72		V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =600V, V _{GS} =0V			1	μA
		V _{DS} =480V, T _J =125°C			10	
I _{GSS}	Gate-Body leakage current	V _{DS} =0V, V _{GS} =±30V			±100	nA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _D =250μA	3	3.9	5	V
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =10V, I _D =3.5A		1	1.2	Ω
g _{FS}	Forward Transconductance	V _{DS} =40V, I _D =3.5A		12		S
V _{SD}	Diode Forward Voltage	I _S =1A, V _{GS} =0V		0.74	1	V
I _S	Maximum Body-Diode Continuous Current				7	A
I _{SM}	Maximum Body-Diode Pulsed Current				28	A
DYNAMIC PARAMETERS						
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =25V, f=1MHz	685	861	1035	pF
C _{oss}	Output Capacitance		65	84	100	
C _{rss}	Reverse Transfer Capacitance		5.2	6.6	7.9	
R _g	Gate resistance	V _{GS} =0V, V _{DS} =0V, f=1MHz	3	4.1	6.2	Ω
SWITCHING PARAMETERS						
Q _g	Total Gate Charge	V _{GS} =10V, V _{DS} =480V, I _D =7A	19.3	23.2	27.8	nC
Q _{gs}	Gate Source Charge		3.8	4.6	5.5	
Q _{gd}	Gate Drain Charge		9.3	11.2	13.5	
t _{D(on)}	Turn-On Delay Time	V _{GS} =10V, V _{DS} =300V, I _D =7A, R _G =25Ω		25		ns
t _r	Turn-On Rise Time			49.5		
t _{D(off)}	Turn-Off Delay Time			51.5		
t _f	Turn-Off Fall Time			43.5		
t _{rr}	Body Diode Reverse Recovery Time	I _F =7A, di/dt=100A/μs, V _{DS} =100V	212	255	306	ns
Q _{rr}	Body Diode Reverse Recovery Charge	I _F =7A, di/dt=100A/μs, V _{DS} =100V	2	2.6	3.1	μC

- A. The value of R_{θJA} is measured with the device in a still air environment with T_A=25°C.
- B. The power dissipation P_D is based on T_{J(MAX)}=150°C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heatsinking is used.
- C. Repetitive rating, pulse width limited by junction temperature T_{J(MAX)}=150°C, Ratings are based on low frequency and duty cycles to keep initial T_J=25°C.
- D. The R_{θJA} is the sum of the thermal impedance from junction to case R_{θJC} and case to ambient.
- E. The static characteristics in Figures 1 to 6 are obtained using <300 μs pulses, duty cycle 0.5% max.
- F. These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsink, assuming a maximum junction temperature of T_{J(MAX)}=150°C. The SOA curve provides a single pulse rating.
- G. L=60mH, I_{AS}=3A, V_{DD}=50V, R_G=25Ω, Starting T_J=25°C

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

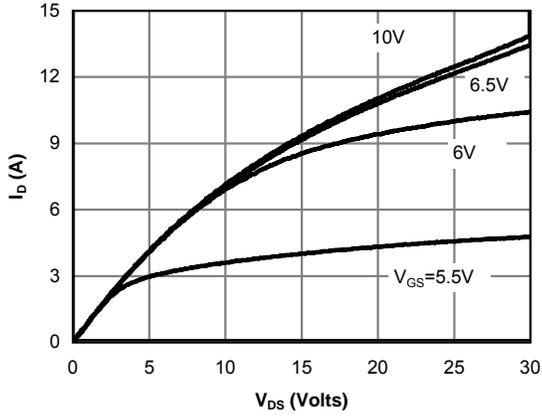


Fig 1: On-Region Characteristics

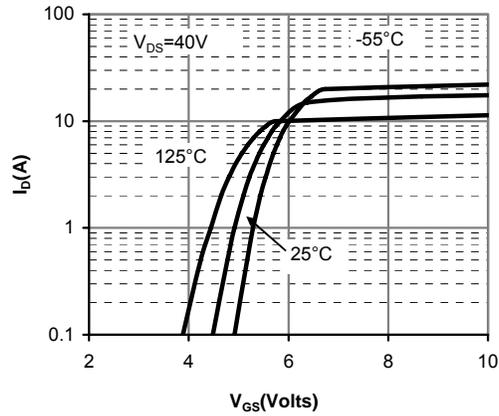


Figure 2: Transfer Characteristics

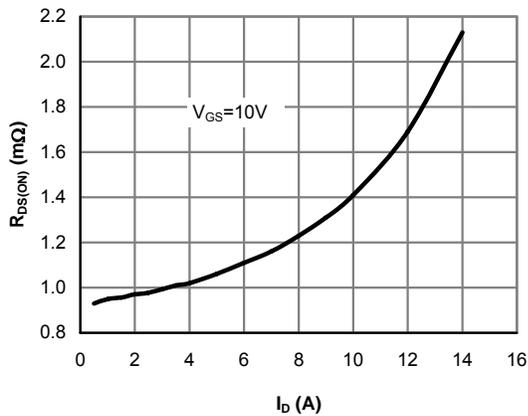


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

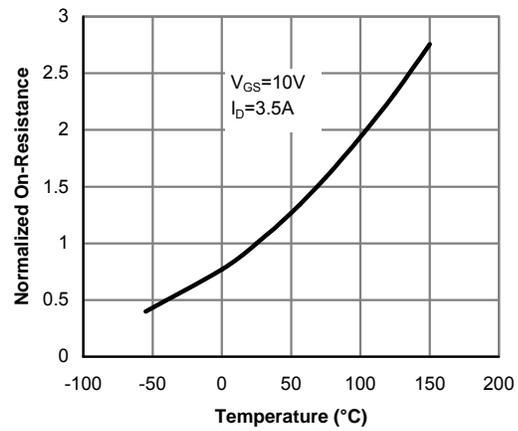


Figure 4: On-Resistance vs. Junction Temperature

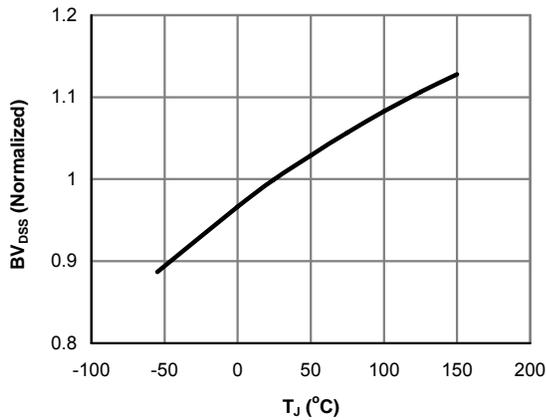


Figure 5: Break Down vs. Junction Temperature

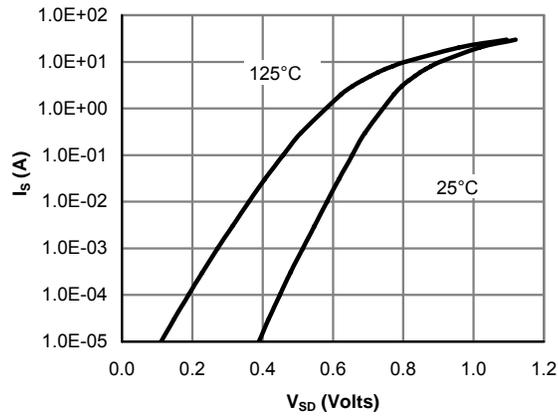


Figure 6: Body-Diode Characteristics

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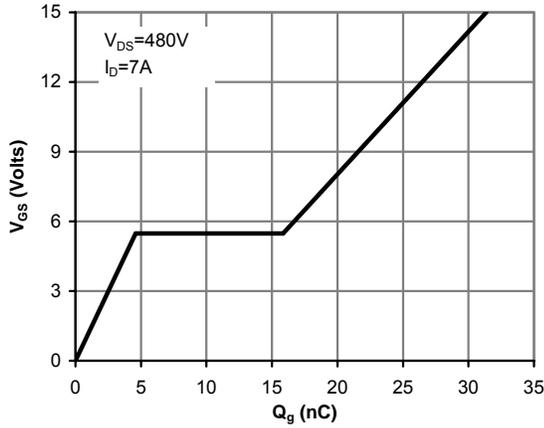


Figure 7: Gate-Charge Characteristics

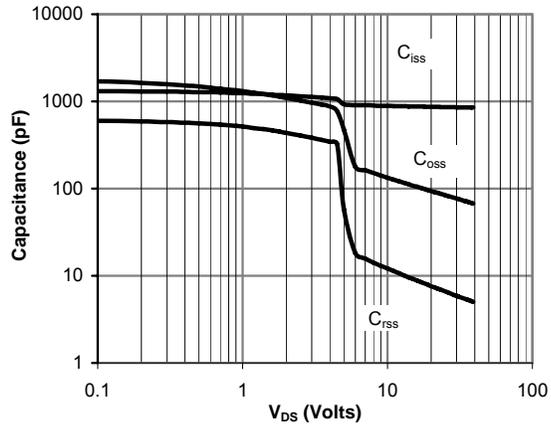


Figure 8: Capacitance Characteristics

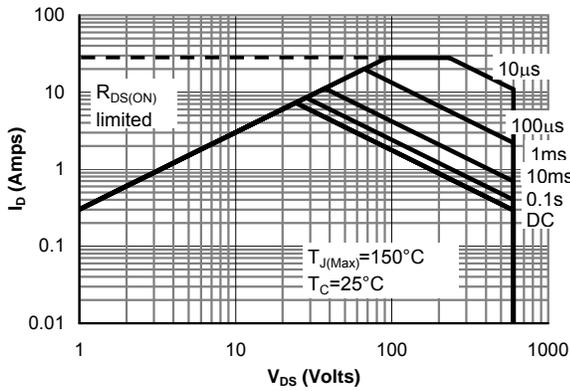


Figure 9: Maximum Forward Biased Safe Operating Area for AOT12N60 (Note F)

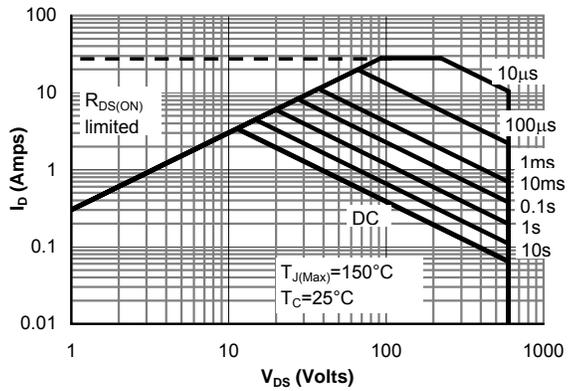


Figure 10: Maximum Forward Biased Safe Operating Area for AOTF12N60 (Note F)

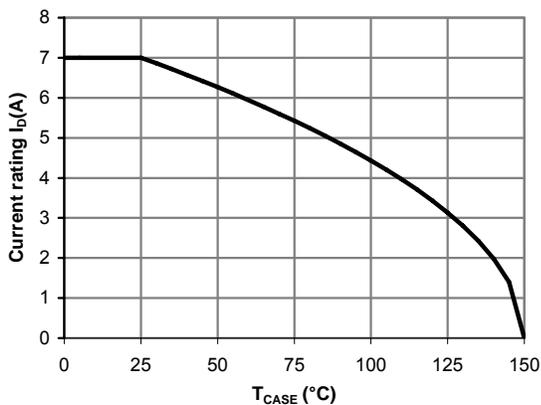


Figure 11: Current De-rating (Note B)

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

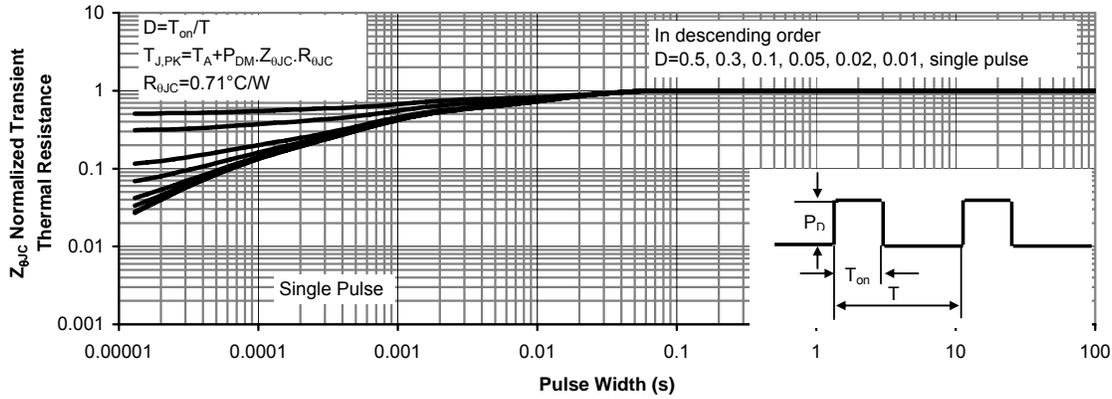


Figure 12: Normalized Maximum Transient Thermal Impedance for AOT7N60 (Note F)

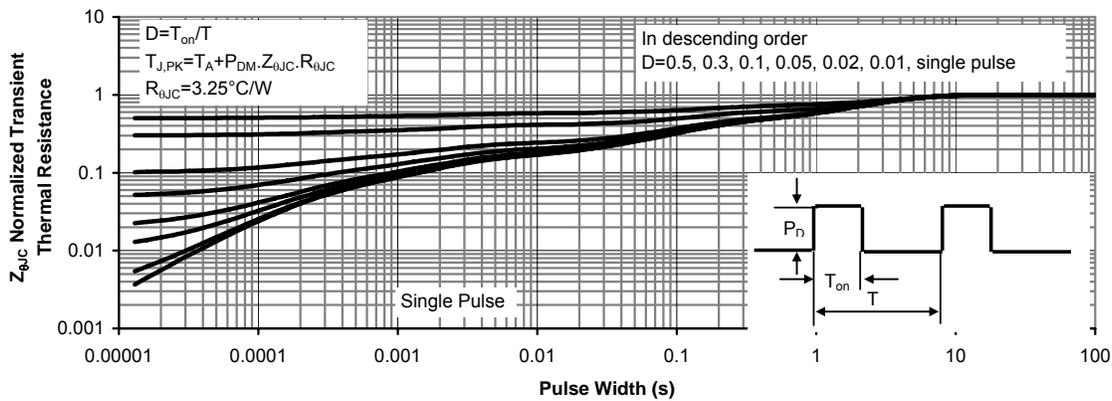
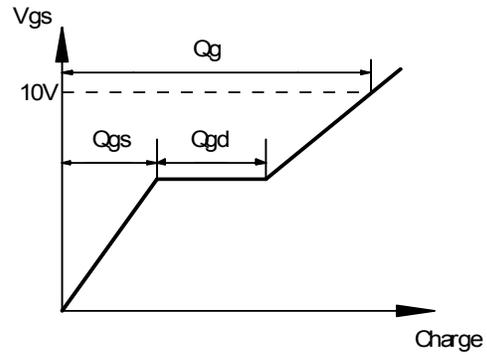
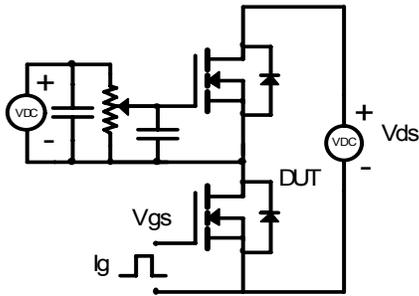
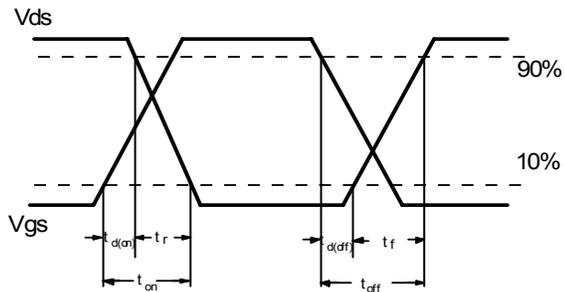
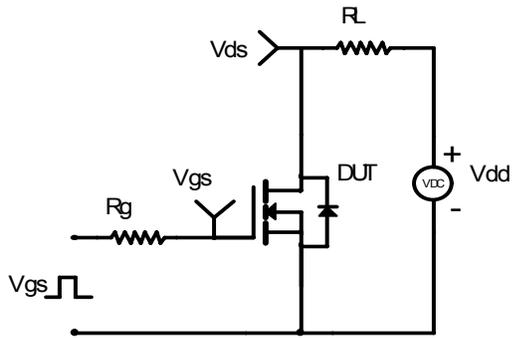


Figure 13: Normalized Maximum Transient Thermal Impedance for AOTF7N60 (Note F)

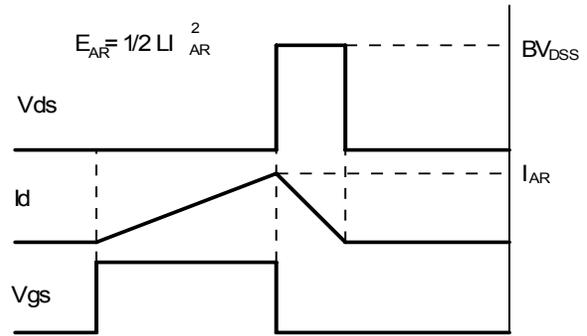
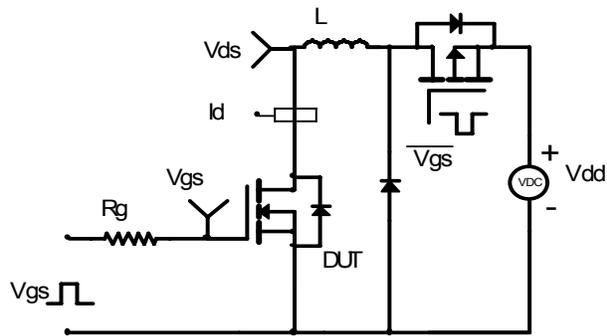
Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching (UIS) Test Circuit & Waveforms



Diode Recovery Test Circuit & Waveforms

